



Features

1.6mm X 0.6mm SMD LED, 1.2mm thickness

Low power consumption

Wide view angle

Package: 4000pcs/reel

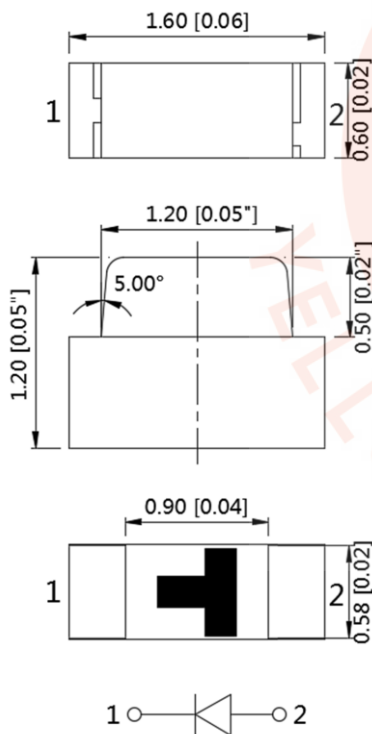
RoHS Compliant

Applications

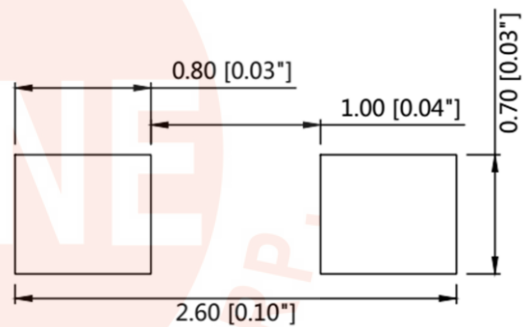
Ideal for back light and indicator

Various colors and lens types available

Package outlines



Recommend Pad Layout



Part No.	Emitted color	Dice	Lens color
YS-060312KCP007-E	Yellow -Green	AlGaInP	Water transparent

Notes:

1. All dimensions are in millimeters (inches);
2. Tolerances are $\pm 0.1\text{mm}$ (0.004inch) unless otherwise noted.



Absolute Maximum Ratings (Ta=25°C)

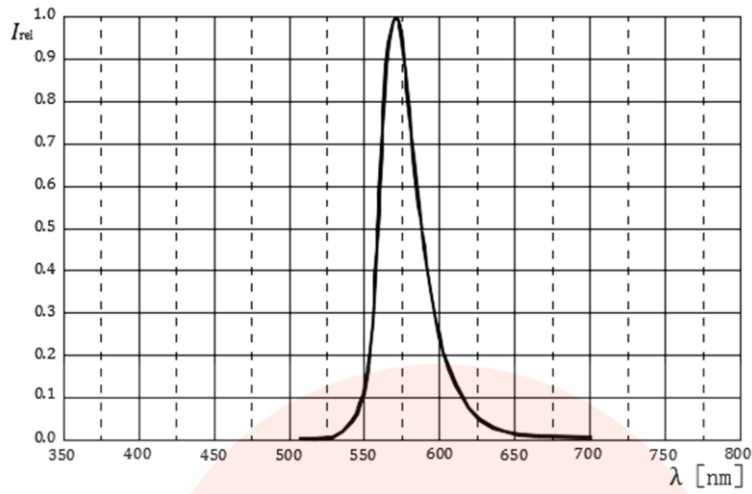
Parameter	Symbol	Value	Unit
Forward current	If	30	mA
Reverse voltage	Vr	5	V
Power dissipation	Pd	72	mW
Operating temperature	Top	-40 ~+85	°C
ESD(Human-body mode)	--	4	KV
Storage temperature	Tstg	-40 ~+85	°C
Peak pulsing current (1/8 duty f=1kHz)	Ifp	125	mA

Electro-Optical Characteristics (Ta=25°C)

Parameter	Test Condition	Symbol	Value			Unit
			Min	Typ	Max	
Wavelength at peak emission	If=20mA	λ_p	--	573	--	nm
Spectral half bandwidth	If=20mA	$\Delta\lambda$	--	17	--	nm
Dominant wavelength	If=20mA	λ_d	566	--	576	nm
Forward voltage	If=20mA	Vf	1.8	--	2.4	V
Luminous intensity	If=20mA	Iv	25	40	80	mcd
Viewing angle at 50% Iv	If=10mA	2 $\theta_{1/2}$	--	120	--	Deg
Reverse current	Vr=5V	Ir	--	--	10	μ A

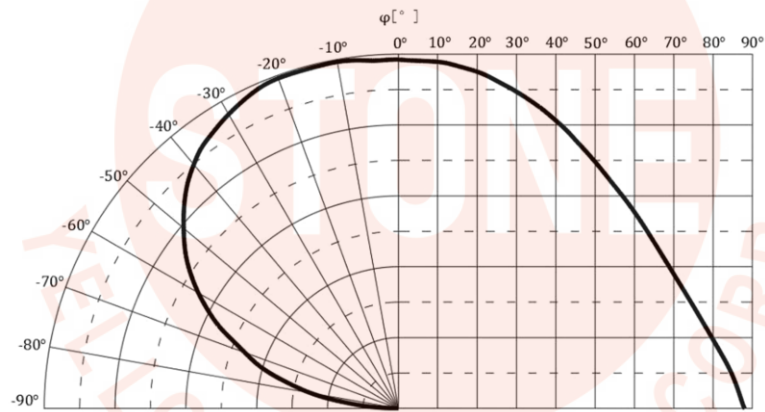
Relative Spectral Emission

IF=20mA, Ta=25°C



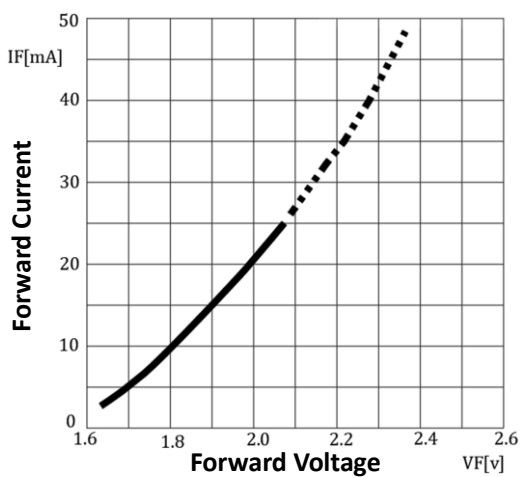
Radiation Characteristics

IF=10mA, Ta=25°C

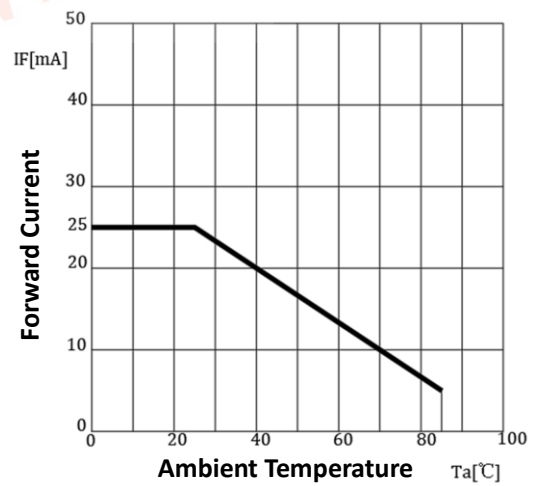


Forward Current vs Forward Voltage

Ta=25°C

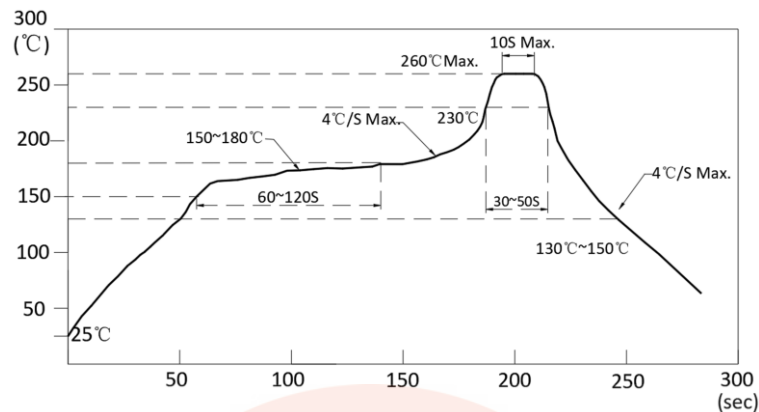


Forward Current Derating Curve



Reflow Profile

■ Reflow Temp/Time



Notes:

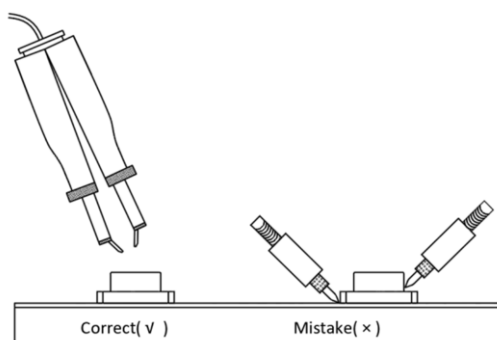
1. We recommend the reflow temperature 245°C ($\pm 5^\circ\text{C}$). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

■ Soldering iron

Basic spec is $\leq 5\text{sec}$ when 320°C ($\pm 20^\circ\text{C}$). If temperature is higher, time should be shorter ($+10^\circ\text{C} \rightarrow -1\text{sec}$). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under 350°C .

■ Rework

1. Customer must finish rework within 5 sec under 340°C .
2. The head of iron cannot touch copper foil
3. Twin-head type is preferred.

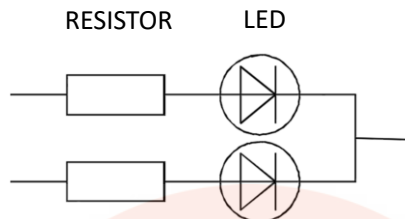


- Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

Handling precautions

1. Drive Method

A LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit below.



2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 60% RH or less.

2.3 After the package is opened, the products should be used within a week or they should be keeping to store at ≤ 20 R.H. with zip-lock sealed.

3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

3.1 $60 \pm 3^{\circ}\text{C}$ x (12~24hrs) and $< 5\%$ RH, taped reel type

3.2 $100 \pm 3^{\circ}\text{C}$ x (45min~1hr), bulk type

3.3 $130 \pm 3^{\circ}\text{C}$ x (15~30min), bulk type



Test Items and Results of Reliability

Test Item	Test Conditions	Standard Test Method	Note	Number of Test
Reflow Soldering	Ta=260±5℃,Time=10±2S	JB/T 10845-2008	3times	0/22
Salt Atmosphere	Ta=35±3℃,PH=6.5~7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5℃ 30±1min ↑→(25℃/5±1min)↓ 100±5℃ 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=-40±5℃~100±5℃, 15±1min dwell	GB/T 2423.22-2012	100cycles	0/22
High Humidity High Temp. Cycling	Ta=30±5℃~65±5℃, 90±5%RH,24hrs/1cycle	GB/T 2423.4-2008	10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5℃,ψ(%)=85±5%RH	GB/T 2423.3-2006	1000hrs	0/22
High Temperature Storage Life	Ta=100±5℃,non-operating	GB/T 2423.2-2008	1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5℃,non-operating	GB/T 2423.1-2008	1000hrs	0/22
Life Test	Ta=26±5℃,@20mA, ψ(%)=25%RH~55%RH	--	1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5℃,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5℃,@20mA	GB/T 2423.1-2008	1000hrs	0/22



Forward Voltage Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
7	1.8	1.9	V
8	1.9	2.0	
9	2.0	2.1	
A	2.1	2.2	
B	2.2	2.3	
C	2.3	2.4	

Luminous Intensity Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
D	25	32	mcd
E	32	40	
F	40	50	
G	50	63	
H	63	80	

Dominant wavelength Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
G9	566	568	nm
G10	568	570	
G11	570	572	
G12	572	574	
G13	574	576	

Group Name on Label (Example DATA: 9FG10 20)

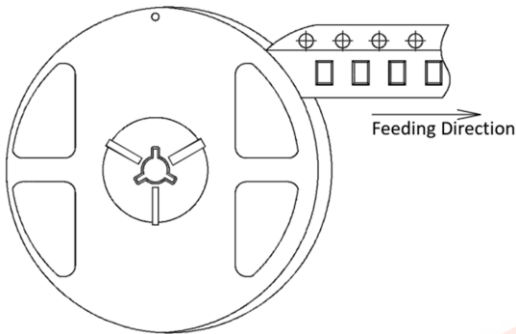
DATA: 9FG10 20	Vf(V)	Iv (mcd)	λ_d (nm)	Test Condition
9→ F→ G10→20	2.0~2.1	40~50	568~570	IF=20mA

Notes:

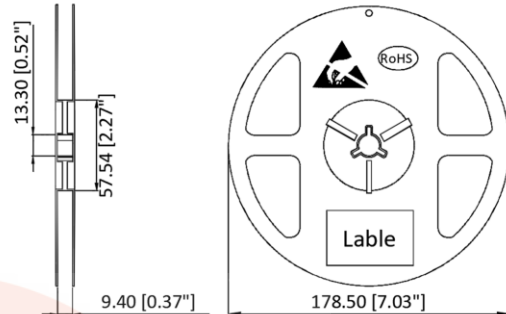
1. The tolerance of luminous intensity (Iv)is $\pm 15\%$.
2. The tolerance of dominant wavelength is $\pm 1\text{nm}$.
3. This specification is preliminary.
4. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

1606 Series SMD Chip LED Lamps Packaging Specifications

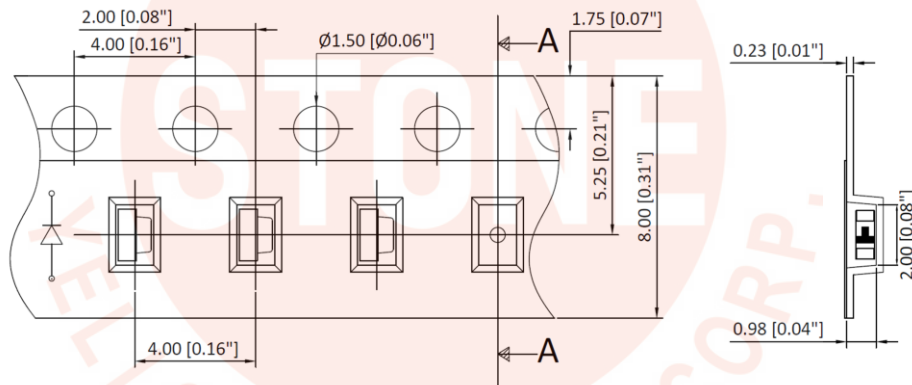
● Feeding Direction



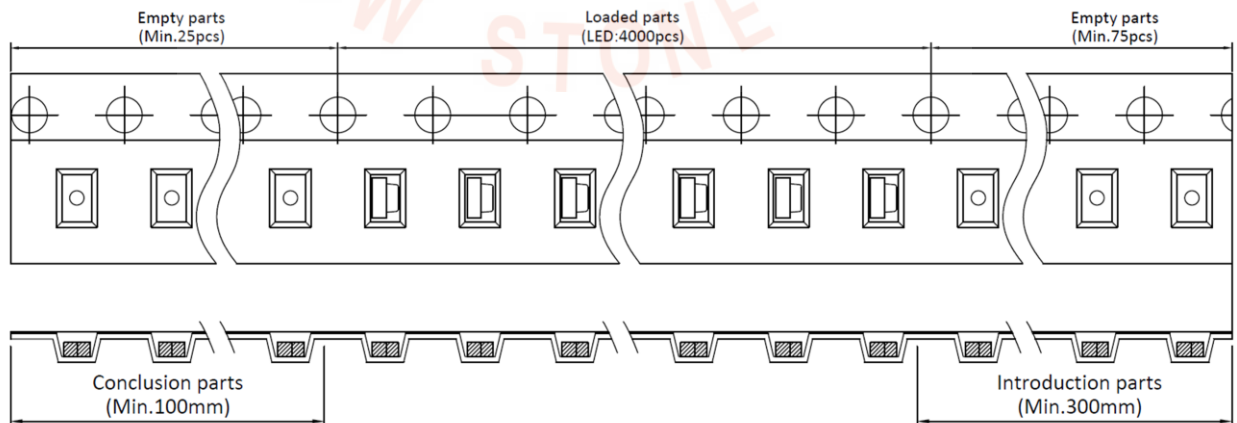
● Dimensions of Reel (Unit: mm)



● Dimensions of Tape (Unit: mm)



● Arrangement of Tape



Notes:

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing lamps is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
4. 4,000pcs/Reel.

1606 Series SMD Chip LED Lamps Packaging Specifications

● Label Explanation



CPN: Customer's Product Number

P/N: Product Number

QTY: Packing Quantity

LOT NO: Lot Number

VF: Forward Voltage Rank

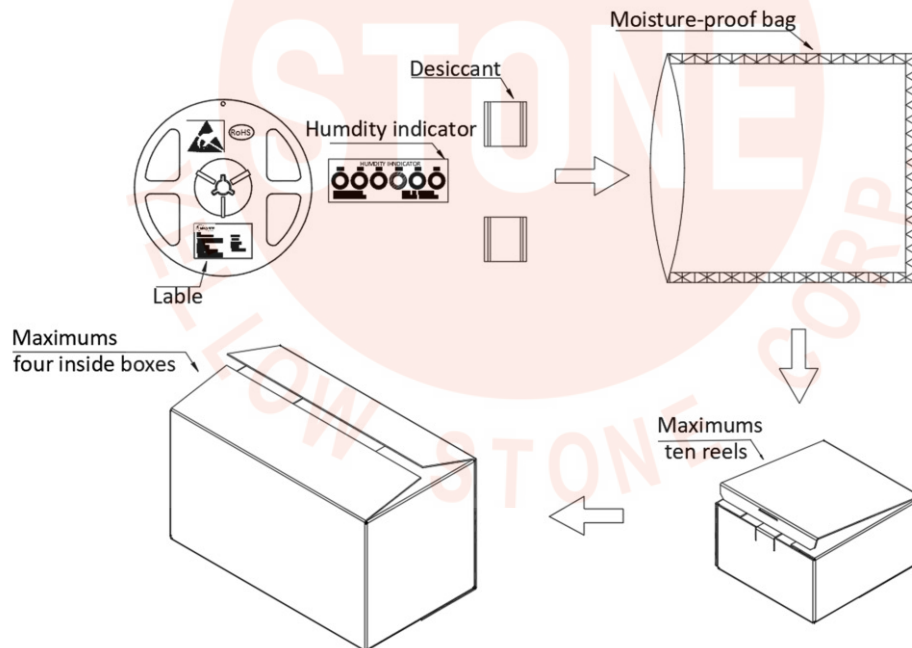
IV: Luminous Intensity Rank

CIE: Chromaticity coordinates Rank

BIN:BIN Code

DATE: Date Of Dispatch

● Transportation Packing



Notes:

Reeled products (numbers of products are 4,000pcs) packed in a seal off moisture-proof bag along with two desiccant one by one, ten moisture-proof bag of maximums packed in an inside box (about size: 240x 220x 120mm) and four inside boxes of maximums are put in the outside box (about size: 460mm x 246mm x 250mm) Together with buffer material, and it is packed. The number of the loading steps of outside box (cardboard box) has it to three steps.